

N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D max T _A = +25°C		
30V	15mΩ @ V _{GS} = 10V	10.7A		
500	18.5mΩ @ V _{GS} = 4.5V	9.6A		

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power management functions

Features

- DIOFET utilizes a unique patented process to monolithically integrate a MOSFET and a Schottky in a single die to deliver:
 - Low R_{DS(ON)} minimizes conduction losses
 - Low V_{SD} reducing the losses due to body diode conduction
 - Low Q_{rr} lower Q_{rr} of the integrated Schottky reduces body diode switching losses
 - Low gate capacitance (Q_g/Q_{gs}) ratio reduces risk of shoot-through or cross conduction currents at high frequencies
 - Avalanche rugged I_{AR} and E_{AR} rated
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

 $\Box D$

ΠD

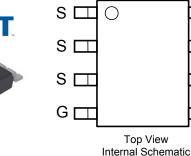
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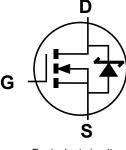
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- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.072 grams (approximate)



Top View





Equivalent circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMG4812SSS-13	SO-8	2500 / Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

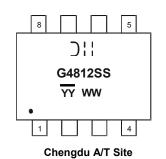
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

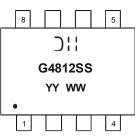
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:





Shanghai A/T Site

);; = Manufacturer's Marking G4812SS = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 13 = 2013) WW = Week (01 - 53) YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 5) V_{GS} = 10V	Steady State	T _A = +25°C T _A = +85°C	Ι _D	8 6.4	A
Continuous Drain Current (Note 6) V_{GS} = 10V	$t \leq 10 \; \text{sec}$	T _A = +25°C T _A = +85°C	I _D	10.7 8.6	А
Continuous Drain Current (Note 6) V_{GS} = 4.5V	$t \le 10 \text{ sec}$	T _A = +25°C T _A = +85°C	ID	9.6 7.7	A
Pulsed Drain Current (Note 7)			I _{DM}	45	A
Avalanche Current (Notes 7 & 8)			I _{AR}	13	A
Repetitive Avalanche Energy (Notes 7 & 8) L = 0.3mH			E _{AR}	25.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.54	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R _{0JA}	81	°C/W
Power Dissipation (Note 6)	PD	2.8	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 6)	R _{0JA}	45	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	—	V	V_{GS} = 0V, I_D = 1mA
Zero Gate Voltage Drain Current	IDSS			150	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)					÷	
Gate Threshold Voltage	V _{GS(th)}	1.0	_	2.3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance			11	15	mΩ	V _{GS} = 10V, I _D = 10.7A
	R _{DS (ON)}		16.5	18.5	11152	V _{GS} = 4.5V, I _D = 9.6A
Forward Transfer Admittance	Y _{fs}		20	—	S	V _{DS} = 5V, I _D = 10.7A
Diode Forward Voltage	V _{SD}		0.36	0.5	V	$V_{GS} = 0V, I_{S} = 1A$
Maximum Body-Diode + Schottky Continuous Current	ls	_	_	5	Α	-
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss		1849		pF	
Output Capacitance	Coss		158	_	pF	V _{DS} =15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		123	_	pF	
Gate Resistance	Rg	0.54	2.0	4.0	Ω	V _{DS} =0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge V _{GS} = 4.5V	Qg		18.5	_	nC	
Total Gate Charge V _{GS} = 10V	Qg	_	43	_	nC	V _{DS} = 15V, V _{GS} = 10V,
Gate-Source Charge	Q _{gs}	_	4.7	_	nC	I _D = 9.6A
Gate-Drain Charge	Q _{gd}	_	4.0	_	nC	
Turn-On Delay Time	t _{D(on)}	_	6.62		ns	
Turn-On Rise Time	tr	_	8.73		ns	V _{GS} = 10V, V _{DS} = 15V,
Turn-Off Delay Time	t _{D(off)}	_	36.41		ns	R_{G} = 3Ω, R_{L} = 15Ω, I_{D} = 1A
Turn-Off Fall Time	t _f	_	4.69		ns	7

Notes:

5. Device mounted on FR-4 PCB with minimum recommended pad layout. The value in any given application depends on the user's specific board design. 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 1 oz. Copper, single sided, device is measured at t \leq 10 sec.

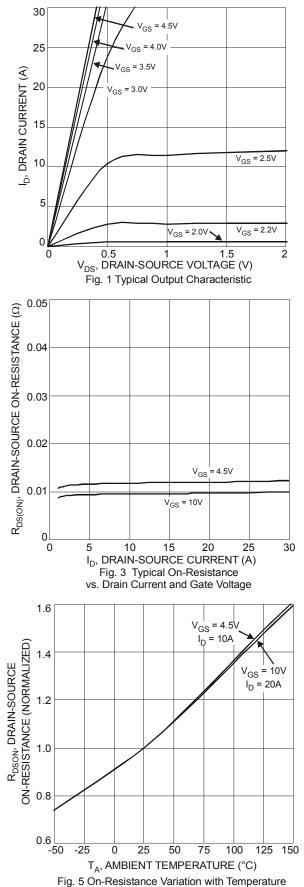
7. Repetitive rating, pulse width limited by junction temperature.

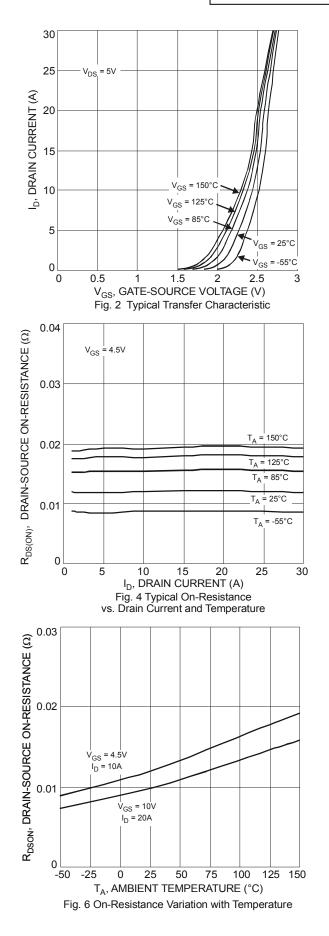
8. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$ 9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to production testing.

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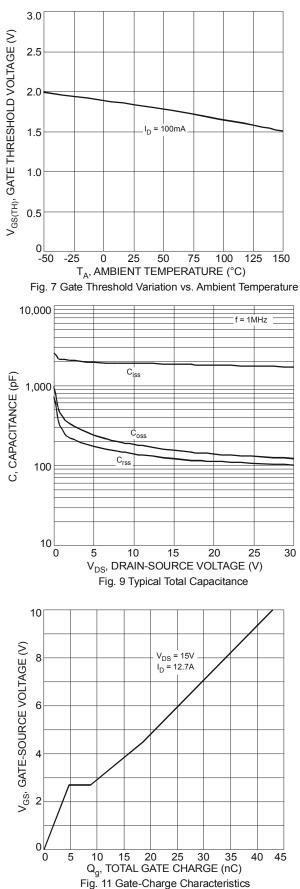


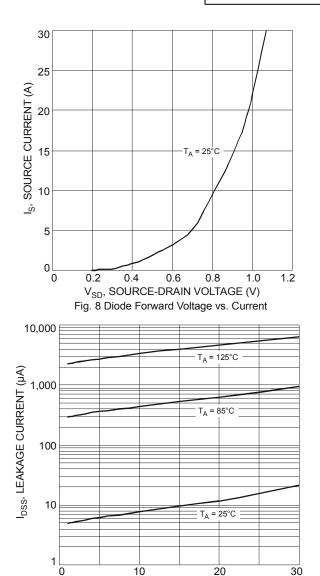




DMG4812SSS







V_{DS}, DRAIN-SOURCE VOLTAGE (V) Fig. 10 Typical Leakage Current vs. Drain-Source Voltage



Max 1.75

0.20

1.50

0.25

0.5

4.95

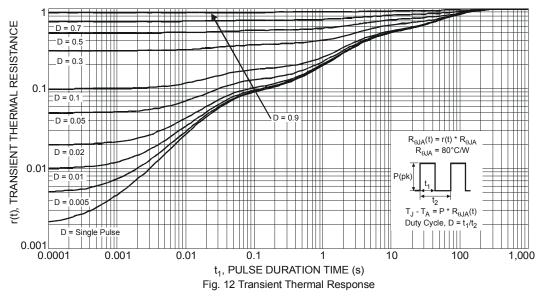
6.10

3.95

0.35

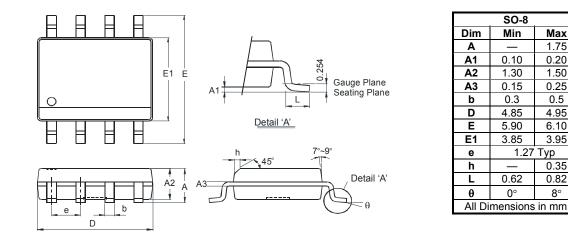
0.82

8°



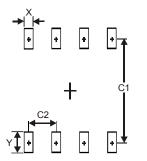
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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